

Clock OSC

XG5032HAN

Product name XG5032HAN 100.000000MHz +/-50ppm CJAA

Product Number / Ordering code X1M0004610002xx

Please refer to the 9.Packing information about xx (last 2 digits)

Output waveform HCSL

Pb free / Complies with EU RoHS directive

Reference weight Typ. 70 mg

1.Absolute maximum ratings

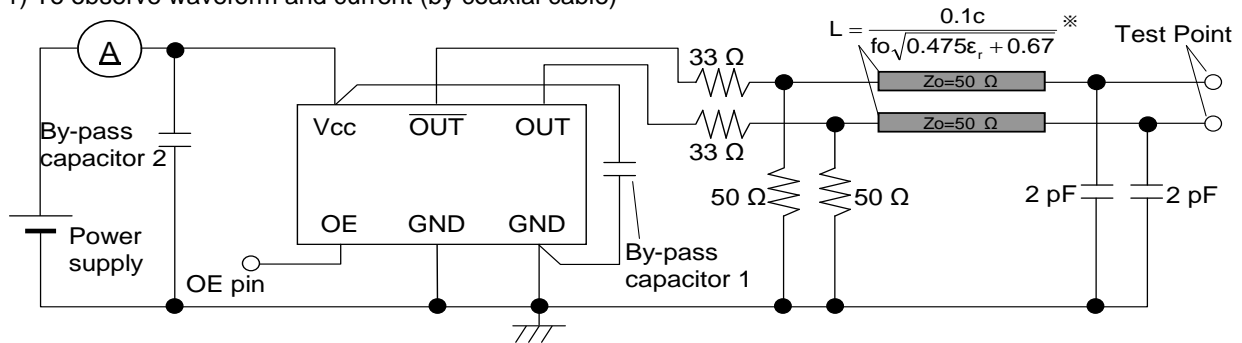
| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions / Remarks |
|------------------------|---------------------|------|------|----------------------|------|---------------------------|
| Maximum supply voltage | V _{cc-GND} | -0.5 | - | 4 | V | - |
| Storage temperature | T _{stg} | -55 | - | 125 | °C | Storage as single product |
| Input voltage | V _{in} | -0.5 | - | V _{cc} +0.5 | V | ST or OE Terminal |

2.Specifications(characteristics)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions / Remarks |
|-----------------------------|-------------------|--------------------|----------|--------------------|-------------------------|---|
| Output frequency | f ₀ | - | 100.0000 | - | MHz | |
| Supply voltage | V _{cc} | 2.97 | 3.3 | 3.63 | V | - |
| Operating temperature | T _{use} | 0 | - | 70 | °C | - |
| Frequency tolerance | f _{tol} | -50 | - | 50 | x10 ⁻⁶ | - |
| Current consumption | I _{cc} | - | - | 35 | mA | OE=V _{cc} ,HCSL=50Ω |
| Stand-by current | I _{std} | - | - | - | mA | - |
| Disable current | I _{dis} | - | - | 15.0 | mA | OE = GND |
| Symmetry | SYM | 45 | - | 55 | % | 0 |
| Output voltage(HCSL) | V _{OH} | - | 0.75 | - | V | - |
| | V _{OL} | - | 0 | - | V | - |
| Crossing voltage | V _{CR} | 0.25 | - | 0.55 | V | - |
| Output load condition(LVDS) | L _{LVDS} | - | 50 | - | Ω | Terminal to GND |
| | R _s | - | 33 | - | Ω | - |
| | C _L | - | 2 | - | pF | - |
| Input voltage | V _{IH} | 0.7V _{cc} | - | - | | - |
| | V _{IL} | - | - | 0.3V _{cc} | | - |
| Rise time | t _r | 1 | - | 4 | ps | [V/n] |
| Fall time | t _f | 1 | - | 4 | ps | [V/n] |
| Start-up time | t _{str} | - | - | 10 | ms | - |
| Jitter | t _{DJ} | - | - | N/A | ps | Deterministic Jitter |
| | T _{RJ} | - | - | N/A | ps | Random Jitter |
| | t _{RMS} | - | - | N/A | ps | δ(RMS of total distribution) |
| | t _{p-p} | - | - | N/A | ps | Peak to Peak |
| | t _{acc} | - | - | N/A | ps | Accumulated Jitter(δ) n=2 to 50000 cycles |
| Phase jitter | t _{PJ} | - | - | 0.3 | ps | Off set Frequency: 12kHz to 20MHz |
| Phase noise | L(f) | - | - | - | dBc/Hz | Off set 1Hz |
| | | - | -61.3 | - | dBc/Hz | Off set 10Hz |
| | | - | -91.2 | - | dBc/Hz | Off set 100Hz |
| | | - | -119.5 | - | dBc/Hz | Off set 1kHz |
| | | - | -144.6 | - | dBc/Hz | Off set 10kHz |
| | | - | -153.6 | - | dBc/Hz | Off set 100kHz |
| Frequency aging | f _{age} | - | - | - | x10 ⁻⁶ /Year | Included in Frequency tolerance 10 years |
| | | - | - | - | | - |

3. Test circuit

- 1) To observe waveform and current (by coaxial cable)



- * Each output line is same length.
- * To measure the disable current, OE pin is connected to GND.
- * $L=176\text{mm}$ (about 7 inch) when $f_0=100\text{ MHz}$, $\epsilon_r=4.7$ (FR-4)

- 2) Measurement condition

- (1) Oscilloscope

- Bandwidth should be 5 times higher than DUT's output frequency (4 GHz).
- Probe ground should be placed closely from test point and lead length should be as short as possible.

- (2) By-pass capacitor 1 (approx. $0.01\text{ }\mu\text{F}$ to $0.1\text{ }\mu\text{F}$) places closely between Vcc and GND.

- (3) By-pass capacitor 2 (approx. $10\text{ }\mu\text{F}$) places closely between power supply terminals on the board.

- (4) Use the current meter whose internal impedance value is small.

- (5) Output line length L is estimated as follows

$$L = \frac{0.1c}{f_0 \sqrt{0.475\epsilon_r + 0.67}}$$

ϵ_r : Relative dielectric constant of the board

f_0 : Output frequency

c : Velocity of light in a vacuum

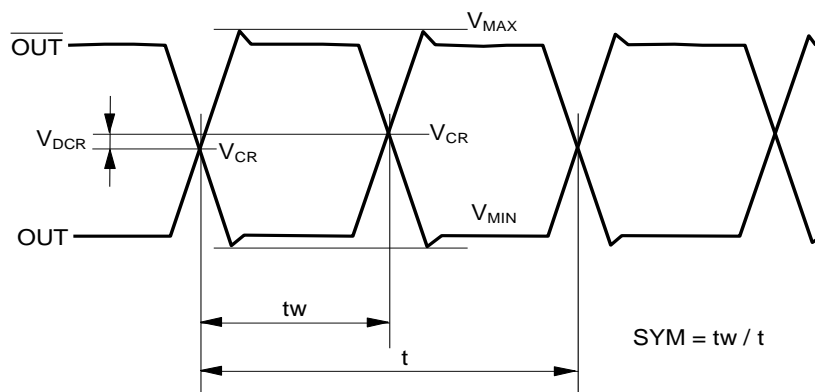
- (6) Power supply

- Start up time ($0\text{ V} \rightarrow 90\%V_{cc}$) of power source should be more than $150\text{ }\mu\text{s}$ and slew rate should be less than $19.8\text{ mV}/\mu\text{s}$.
- Impedance of power supply should be as low as possible.

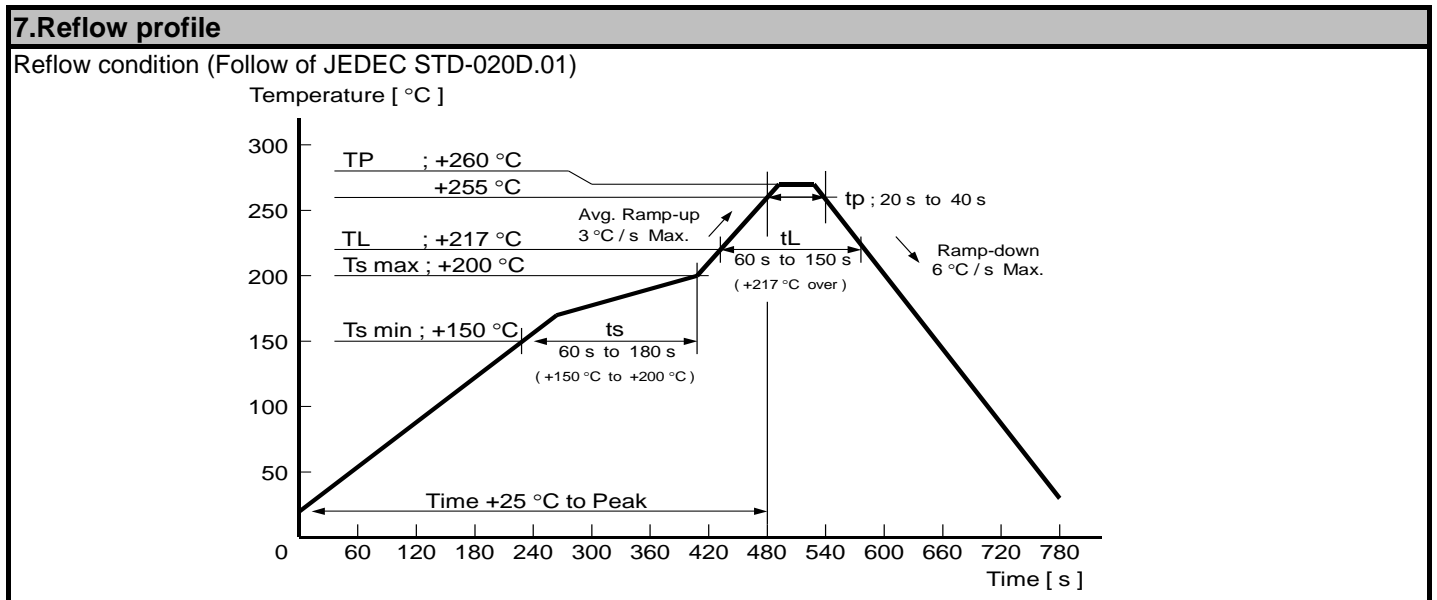
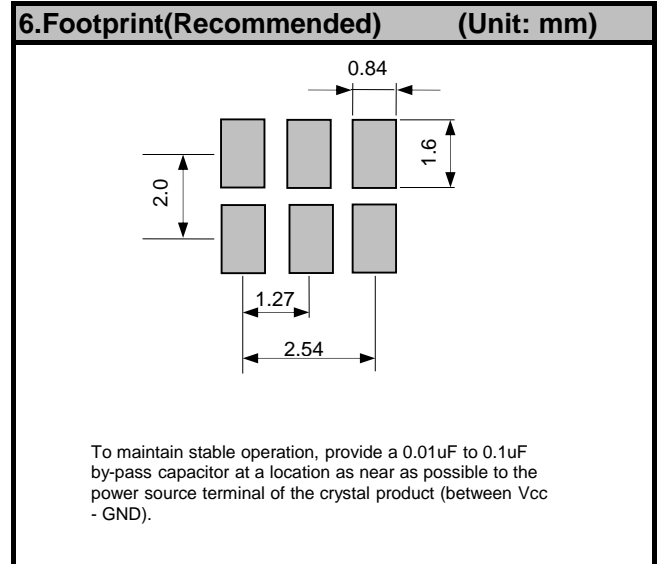
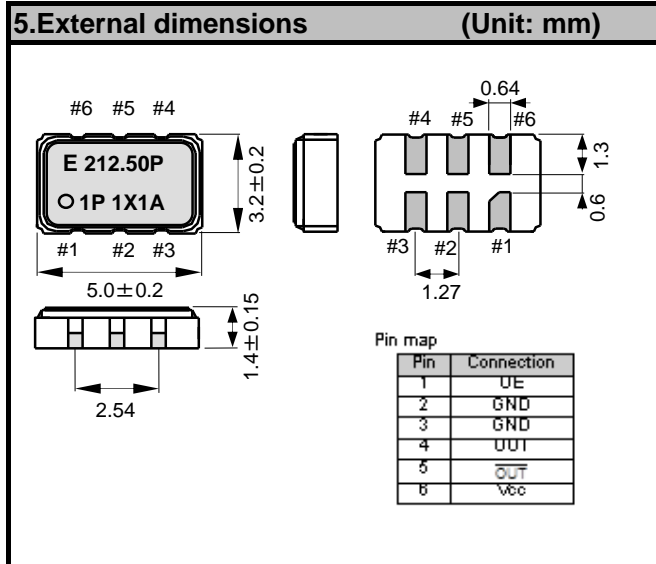
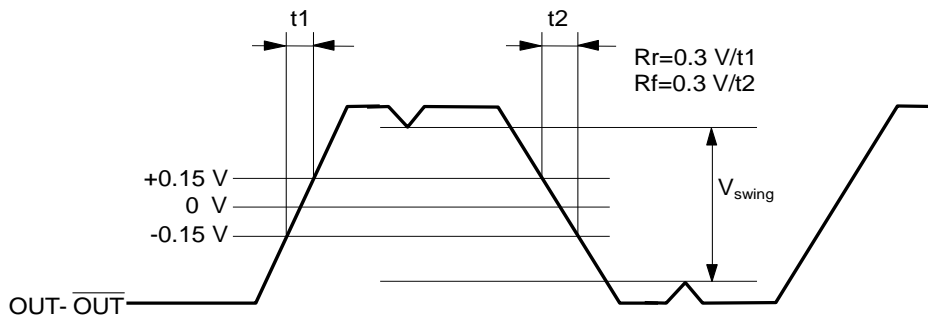
4. Timing chart

- 1) Output waveform and level

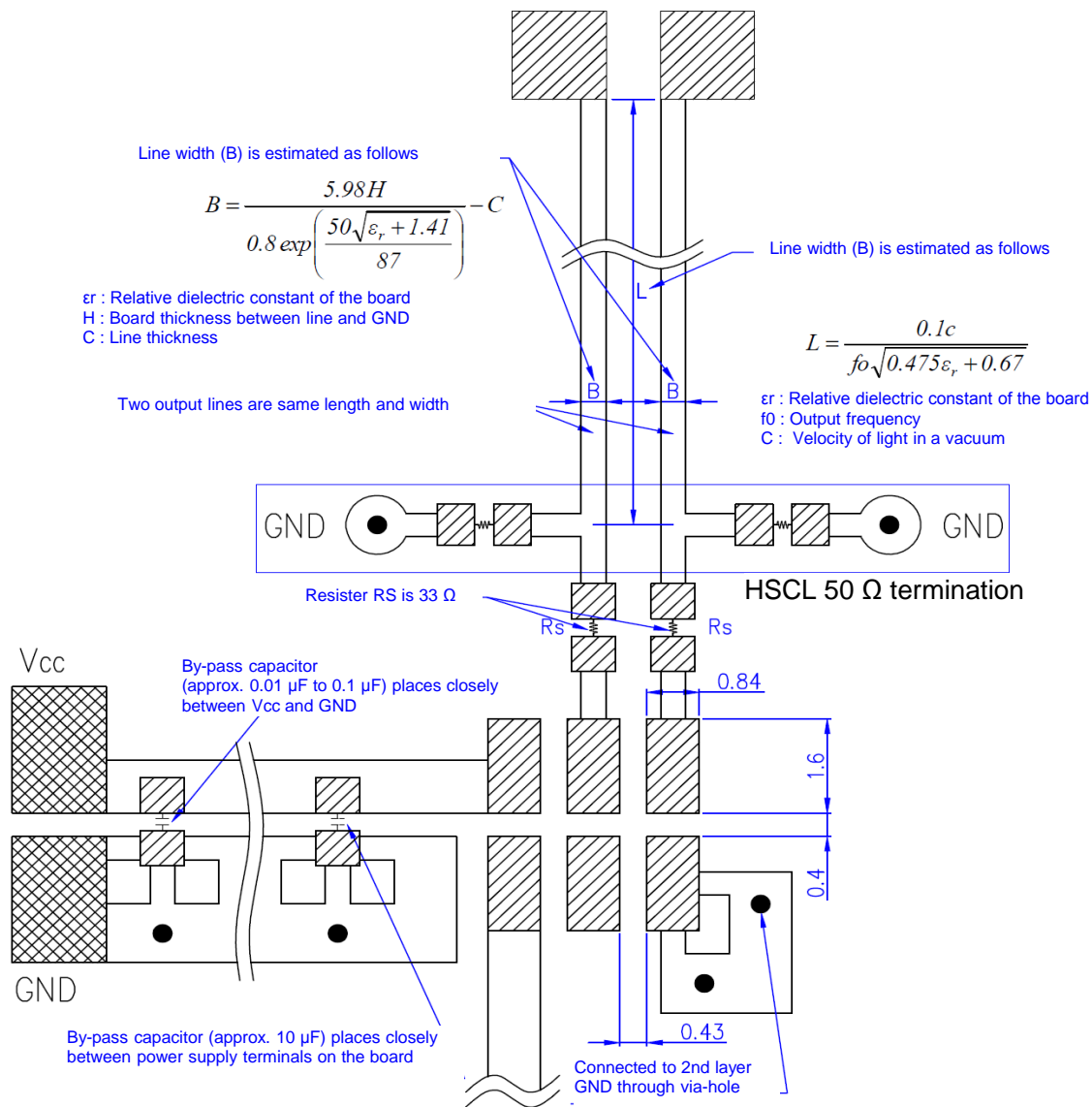
- OUT and OUT-bar



• OUT-OUT



8.PCB layout (2 layers, 2nd layer is all GND pattern)



- * By-pass capacitor (approx. 0.01 μF to 0.1 μF) places closely between Vcc and GND.
 - * By-pass capacitor (approx. 10 μF) places closely between power supply terminals on the board.
 - * Please design the two output lines by characteristic impedance 50 Ω and same length,
 - * Reflection wave occurs in two output lines after 50 Ω terminal resistances.
- In the case except output line length L shown in the upper figure, reflection wave may influence the rise and fall waveform and electric characteristic may not satisfy this specifications.

9.Packing information

[1] Product number last 2 digits code(xx) description

The recommended code is "00"

X1M0004610002xx

| Code | Condition | Code | Condition |
|------|------------------------------|------|----------------|
| 01 | Any Q'ty vinyl bag(Tape cut) | 13 | 500pcs / Reel |
| 11 | Any Q'ty / Reel | 00 | 1000pcs / Reel |
| 12 | 250pcs / Reel | | |

[2] Taping specification

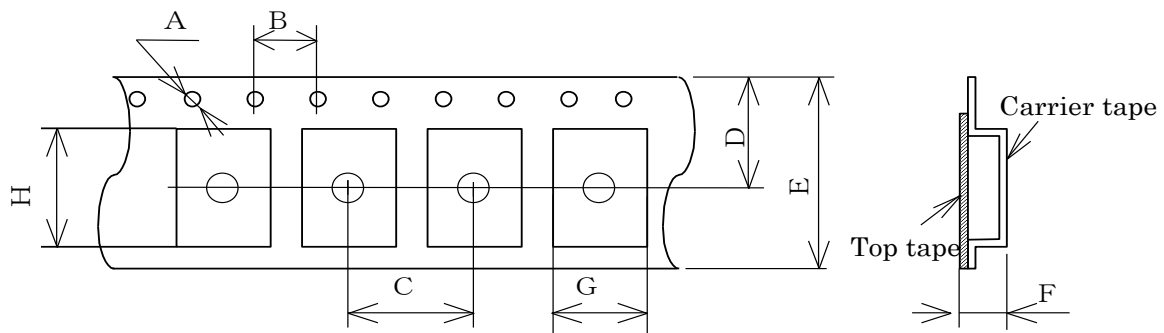
Subject to EIA-481 & IEC-60286

(1) Tape dimensions

Material of the Carrier Tape : PS

Material of the Top Tape : PET+PE

Unit: mm

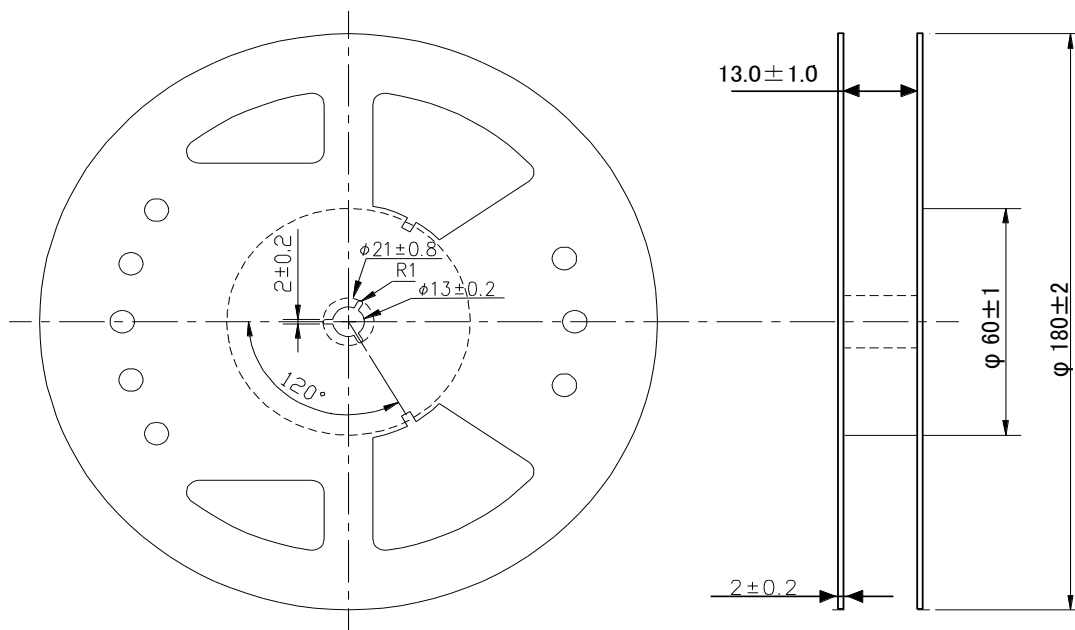


| Symbol | A | B | C | D | E | F | G | H |
|--------|-------------------------|---------------|---------------|----------------|----------------|----------------|---------------|---------------|
| Value | $\phi 1.5$ $+0.1/-0$ | 4.0 ± 0.1 | 8.0 ± 0.1 | 7.25 ± 0.2 | 12.0 ± 0.2 | 1.40 ± 0.1 | 3.5 ± 0.1 | 5.4 ± 0.1 |

(2) Reel dimensions

Center material : PS

Material of the Reel : PS



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